

09-24-1999

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U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original document or copy thereof.

1. Name of conveying party(ies):

- 1) Tsiu C. Chan
2)
3)
4)
5)
6)

MLD
9-10-99

Additional names of conveying parties attached? ☐ Yes ☒ No

2. Name and address of receiving party:

Name: STMicroelectronics, Inc.

Internal Address: _____

Street Address: 1310 Electronics DriveCity: Carrollton State TexasZip: 75006-5039Additional names & addresses attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Dates:

- 1) September 3, 1999 4) _____
2) _____ 5) _____
3) _____ 6) _____

4. Application number(s) or registration number(s):

If this document is being filed together with a new application,
the execution date of the application is September 10, 1999.

A. Patent Application No(s).

091393119

B. Patent No(s).

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: STMicroelectronics, Inc.Internal Address: Lisa Jorgenson, Esq.Street Address: 1310 Electronics DriveCity: Carrollton State: TX ZIP: 75006-50396. Total number of applications and patents involved..... 17. Total Fee (37 CFR 3.41): \$40

- ☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit account number:

19-1090

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9. Statement and signature. 40.00 DP

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Kimton N. Eng

Name of Person Signing

Signature9/10/99
DateTotal number of pages including cover sheet, attachments, and document: 2

ASSIGNMENT

WHEREAS, I, Tsiu C. Chan (hereinafter referred to as ASSIGNOR), having a post office address of 1633 Camero Drive, Carrollton, Texas 75006, am the sole inventor of an invention entitled "RADIATION HARDENED SEMICONDUCTOR MEMORY," as described and claimed in the specification forming part of a continuation-in-part application for United States letters patent executed concurrently herewith; this application is a continuation-in-part of U.S. Patent Application No. 09/209,654, filed December 10, 1998, which application is pending.

WHEREAS, STMicroelectronics, Inc., (hereinafter referred to as ASSIGNEE), a corporation of the State of Texas having a place of business at 1310 Electronics Drive, Carrollton, Texas 75006-5039, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR hereby sells, assigns and transfers unto said ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR had this assignment, transfer and sale not been made. ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR agrees to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

Sept 3, 1999
Date

Tsiu C. Chan
Tsiu C. Chan

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98-C-173 (CIP) (850063.416C3)